

Technical Data Sheet

1.9mm Round Subminiature Lead LEDs

Features

- Package in 12mm tape on 7" diameter reels.
- Compatible with automatic placement equipment.
- EIA Std. package.
- Mono-color type.
- Pb-free
- The product itself will remain within RoHS compliant version.

Descriptions

- The 95-21 SMD taping is much smaller than leaded components.
 Thus enable smaller board size. Higher packing density. Reduced storage space and finally smaller equipment to be obtained.
- Besides, light weight makes them ideal for miniature applications.
- Furthermore by automation assembly machines the accuracy is anticipated.

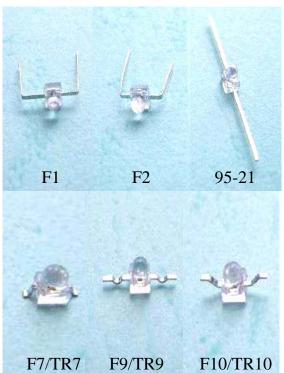
Applications

- Small indicator for indoor applications.
- Flat backlight for LCD, switches and symbols.
- Indicator and backlight in office equipment.
- Indicator and backlight for battery driven equipment.
- Indicator and backlight for audio and video equipment.
- Automotive : backlighting in dashboards and switches.
- Telecommunication: indicator and backlighting in telephone and fax.

Device Selection Guide

DA DE MO	C	T Cala	
PART NO.	Material	Emitted Color	Lens Color
95-21SUBC/S400-XX/XXX	InGaN	Super Blue	Water Clear

95-21SUBC/S400-XX/XXX



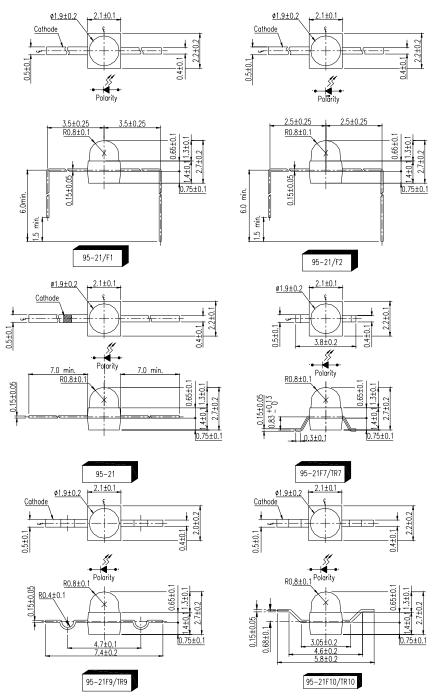
Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 2 Page: 1 of 10 Device No.: SZDLE-952-030 Prepared date: 07-29-2005 Prepared by: bianchangyou

Downloaded from Elcodis.com electronic components distributor



95-21SUBC/S400-XX/XXX

Package Outline Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm ,Unit = mm

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95-21SUBC/S400-XX/XXX

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	V_R	5	V	
Forward Current	I_{F}	25	mA	
Operating Temperature	Topr	-40 ~ +85	$^{\circ}\!\mathbb{C}$	
Storage Temperature	Tstg	-40 ~ +100	$^{\circ}\!\mathbb{C}$	
Electrostatic Discharge	ESD	150	V	
Power Dissipation	Pd	110	mW	
Peak Forward Current (Duty 1/10 @ 1KHz)	I_{FP}	100	mA	
		Reflow Soldering: 260 °C for 10		
Soldering Temperature	Tsol	sec.		
		Hand Soldering : 350 °C for 3 sec.		

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95-21SUBC/S400-XX/XXX

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Chip Rank	MIN.	TYP.	MAX.	Unit	Condition	
Luminous Intensity	$ m I_{V}$	A3		24			I _F =2mA	
			320	500		mcd	I _F =20mA	
		A4		30			I _F =2mA	
			400	630			I _F =20mA	
		A5		38			I _F =2mA	
			500	800			I _F =20mA	
Viewing Angle	2 \theta 1/2			25		deg		
Peak Wavelength	λp			468		nm	I _F =20mA	
Dominant Wavelength	λd			470		nm		
Spectrum Radiation Bandwidth	Δλ			35		nm		
Forward Voltage	V_{F}			3.5	4.3	V		
Reverse Current	I_R				50	μ A	V _R =5V	

*95-21SUBC/S400-<u>XX</u> / <u>XXX</u>

1 2

1:Chip Rank

2:Packing Method:

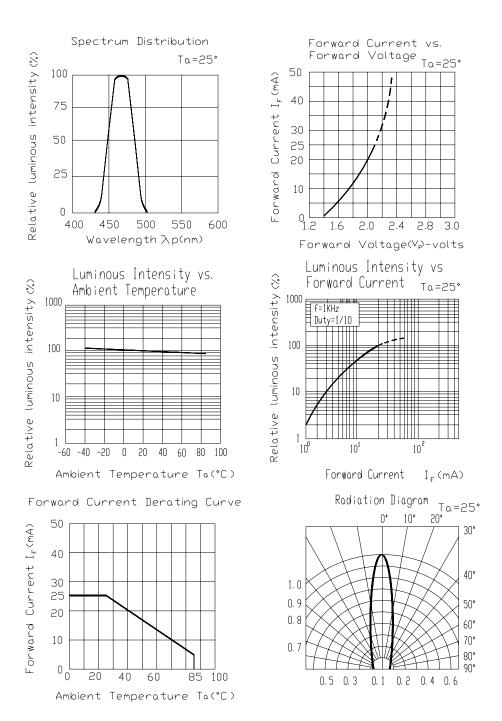
(1) None,F1,F2, F7,F9,F10: Bulk

(2) TR7,TR9,TR10 : Taping

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95-21SUBC/S400-XX/XXX

Typical Electro-Optical Characteristics Curves



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95-21SUBC/S400-XX/XXX

Label explanation

CAT: Luminous Intensity Rank

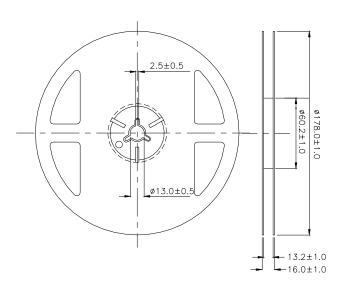
HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank



Reel & Carrier Tape Dimensions





Note: The tolerances unless mentioned are ± 0.1 , unit=mm.

Everlight Electronics Co., Ltd. Device No.: SZDLE-952-030

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Rev. 2

Page: 6 of 10

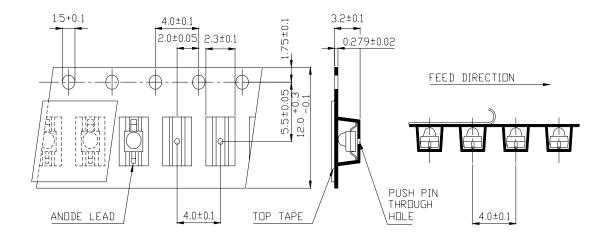
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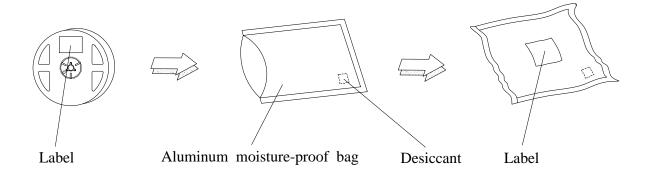
95-21SUBC/S400-XX/XXX

Loaded quantity 1000 PCS per reel



Note: The tolerances unless mentioned is ± 0.1 mm ,Unit = mm

Moisture Resistant Packaging



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Page: 7 of 10

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95-21SUBC/S400-XX/XXX

Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90 %

LTPD: 10 %

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5 sec.	6 Min.	22 Pcs.	0/1
2	Temperature Cycle	H:+100°C 15 min. ∫ 5 min. L:-40°C 15 min.	300 Cycles	22 Pcs.	0/1
3	Thermal Shock	$H: +100^{\circ}\mathbb{C}$ 5 min. $\int 10 \text{ sec.}$ $L: -10^{\circ}\mathbb{C}$ 5 min.	300 Cycles	22 Pcs.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 Pcs.	0/1
5	Low Temperature Storage	Temp. : -40°ℂ	1000 Hrs.	22 Pcs.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 Pcs.	0/1
7	High Temperature / High Humidity	85°C / 85% RH	1000 Hrs.	22 Pcs.	0/1

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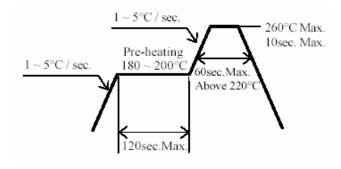


95-21SUBC/S400-XX/XXX

Precautions For Use

- 1. Over-current-proof
 - Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).
- 2. Storage
- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 The LEDs should be used within a year.
- 2.4 After opening the package, the LEDs should be kept at 30°C or less and 70%RH or less.
- 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.
- 2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

 Baking treatment: 60±5°C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.
- 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

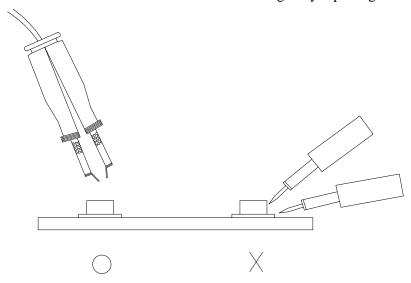
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95-21SUBC/S400-XX/XXX

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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